

General Description

The MY6B03C is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent $R_{DS(ON)}$ and gate charge for most of the small power switching and load switch applications.

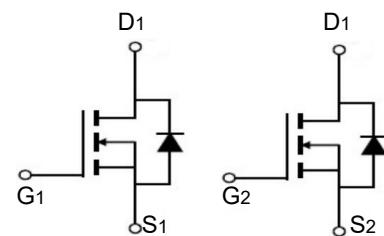
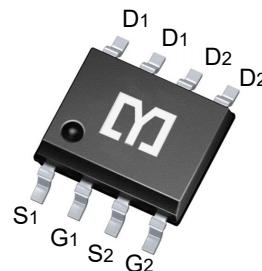


Features

V_{DSS}	30	V
I_D	6	A
$R_{DS(ON)}(\text{at } V_{GS}=10\text{V})$	<20	$\text{m}\Omega$
$R_{DS(ON)}(\text{at } V_{GS}=4.5\text{V})$	<30	$\text{m}\Omega$

Application

- Battery protection
- Load switch
- Uninterruptible power supply



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MY6B03C	SOP-8	6B03C	3000

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	6.0	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	4.8	A
I_{DM}	Drain Current – Pulsed ¹	30	A
EAS	Single Pulse Avalanche Energy ²	14	mJ
IAS	Single Pulse Avalanche Current ²	17	A
P_D	Power Dissipation ($T_c=25^\circ\text{C}$)	2.1	W
	Power Dissipation – Derate above 25°C	0.017	$\text{W}/^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	60	°C/W

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	30	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C $I_D=1\text{mA}$	---	0.04	---	V/°C
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=30\text{V}$, $V_{GS}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=24\text{V}$, $V_{GS}=0\text{V}$, $T_J=125^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$	---	---	± 100	nA

$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance ³	$V_{GS}=10\text{V}$, $I_D=6\text{A}$	---	15	20	mΩ
		$V_{GS}=4.5\text{V}$, $I_D=3\text{A}$	---	23	30	$\text{m}\Omega$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D = 250\mu\text{A}$	1.2	1.5	2.5	V
$\Delta V_{GS(\text{th})}$	$V_{GS(\text{th})}$ Temperature Coefficient		---	-4	---	mV/°C
g_{fs}	Forward Transconductance	$V_{DS}=10\text{V}$, $I_D=6\text{A}$	---	13	---	S

Q_g	Total Gate Charge ^{3, 4}	$V_{DS}=15\text{V}$, $V_{GS}=4.5\text{V}$, $I_D=5\text{A}$	---	4.1	8	nC
Q_{gs}	Gate-Source Charge ^{3, 4}		---	1	2	
Q_{gd}	Gate-Drain Charge ^{3, 4}		---	2.1	4	
$T_{d(on)}$	Turn-On Delay Time ^{3, 4}	$V_{DD}=15\text{V}$, $V_{GS}=10\text{V}$, $R_G=6\text{k}\Omega$ $I_D=1\text{A}$	---	2.6	5	ns
T_r	Rise Time ^{3, 4}		---	7.2	14	
$T_{d(off)}$	Turn-Off Delay Time ^{3, 4}		---	15.8	30	
T_f	Fall Time ^{3, 4}		---	4.6	9	
C_{iss}	Input Capacitance	$V_{DS}=25\text{V}$, $V_{GS}=0\text{V}$, $F=1\text{MHz}$	---	345	500	pF
C_{oss}	Output Capacitance		---	55	80	
C_{rss}	Reverse Transfer Capacitance		---	32	55	
R_g	Gate resistance	$V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, $f=1\text{MHz}$	---	3.2	6.4	Ω

I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	7.5	A
I_{SM}	Pulsed Source Current ³		---	---	30	A
V_{SD}	Diode Forward Voltage ³	$V_{GS}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1	V
t_{rr}	Reverse Recovery Time	$V_{GS}=0\text{V}$, $I_s=1\text{A}$, $di/dt=100\text{A}/\mu\text{s}$ $T_J=25^\circ\text{C}$	---	---	---	ns
Q_{rr}	Reverse Recovery Charge		---	---	---	nC

Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- The data tested by pulsed, pulse width DD=25V, VGS=10V, L=0.1mH, IAS=17A., RG≤25 300us , duty cycle ,Starting TJ=25≤°C. 2%.
- Essentially independent of operating temperature.

Typical Characteristics

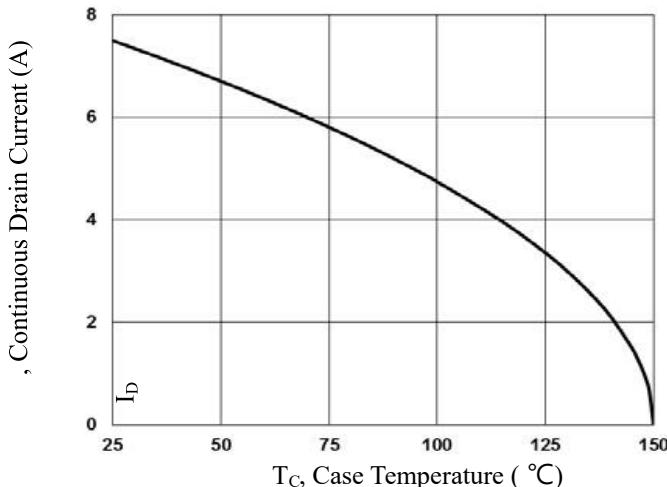
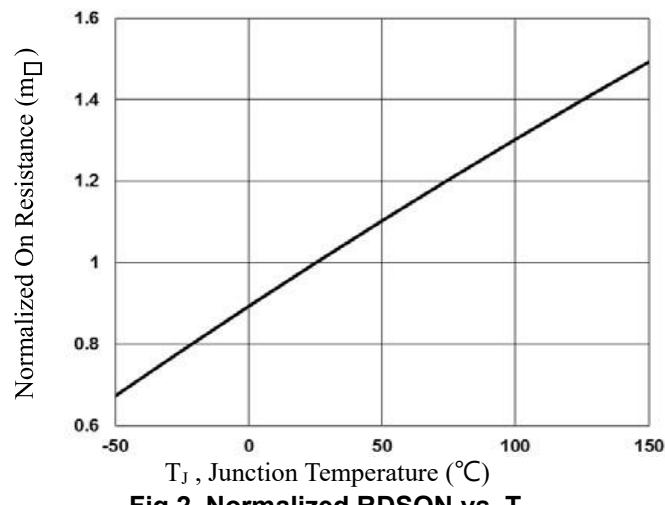
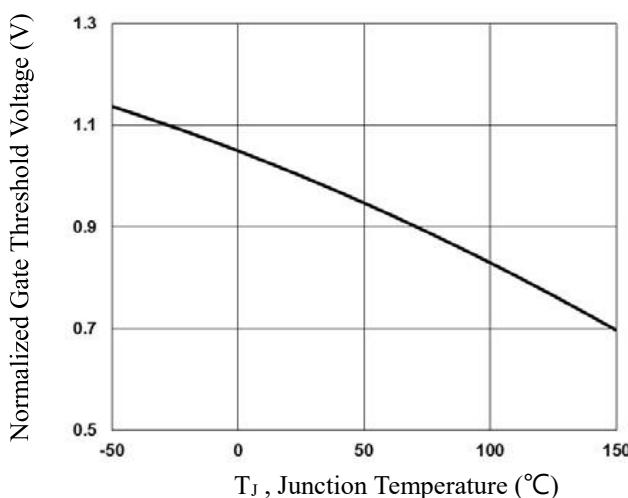
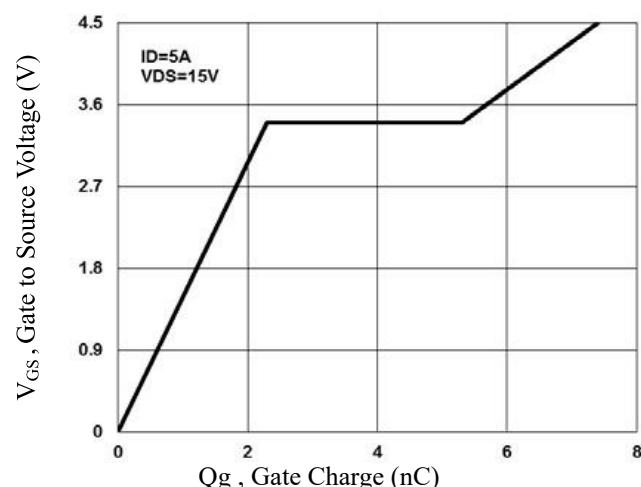
Fig.1 Continuous Drain Current vs. T_c Fig.2 Normalized $R_{DS(on)}$ vs. T_j Fig.3 Normalized V_{th} vs. T_j 

Fig.4 Gate Charge Waveform

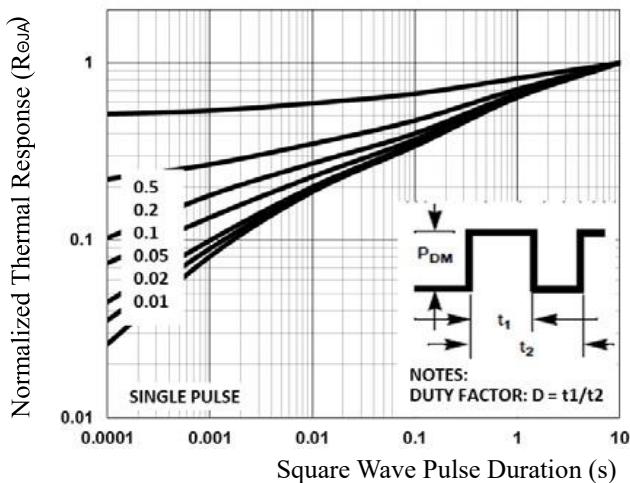


Fig.5 Normalized Transient Response

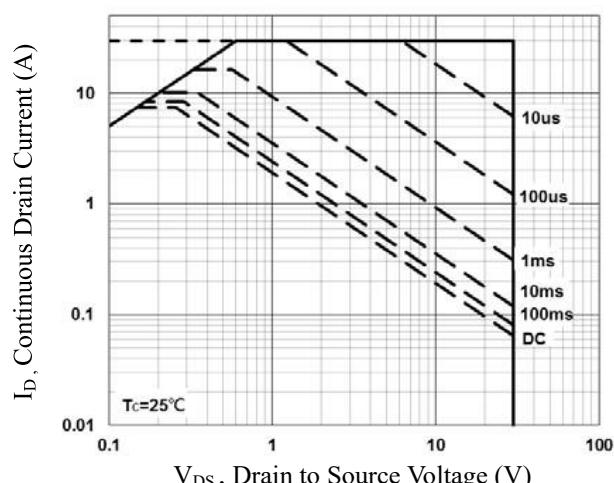


Fig.6 Maximum Safe Operation Area

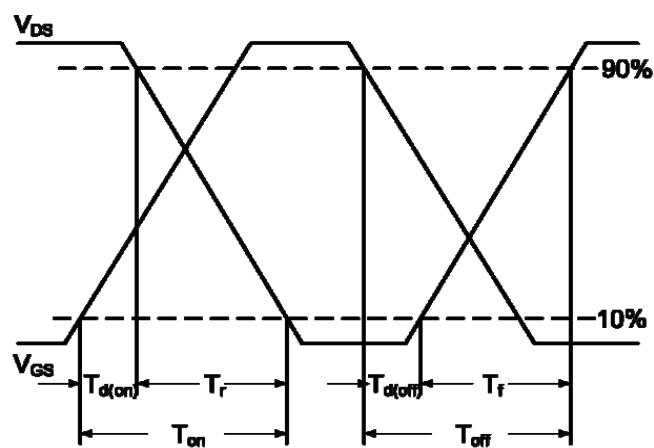


Fig.7 Switching Time Waveform

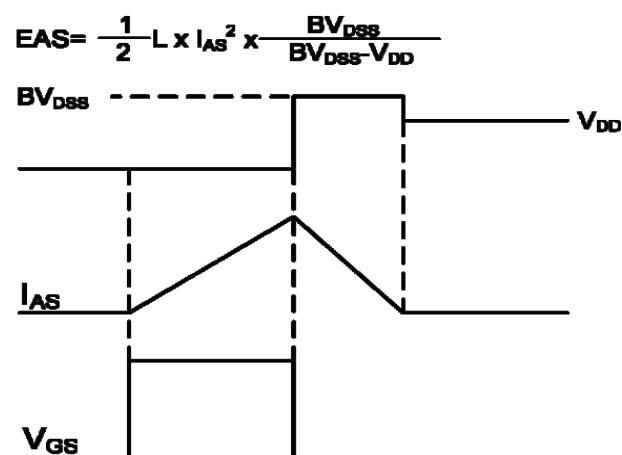
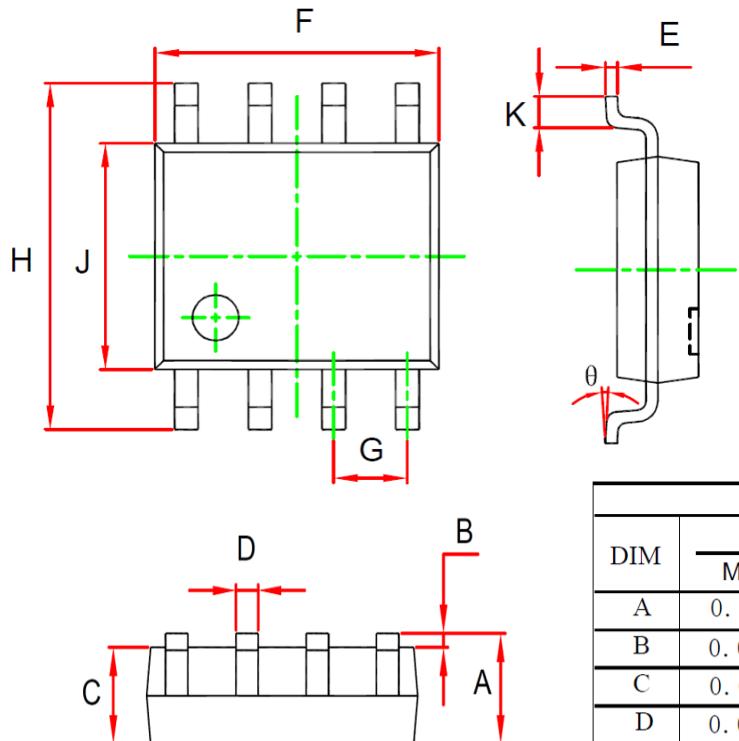


Fig.8 EAS waveform

Package Mechanical Data-SOP-8



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.053	0.069	1.350	1.750	
B	0.004	0.010	0.100	0.250	
C	0.053	0.061	1.350	1.550	
D	0.013	0.020	0.330	0.510	
E	0.007	0.010	0.170	0.250	
F	0.189	0.197	4.800	5.000	
G	0.050 (BSC)		1.270	(BSC)	
H	0.228	0.244	5.800	6.200	
J	0.150	0.157	3.800	4.000	
K	0.016	0.050	0.400	1.270	
θ	0°	8°	0°	8°	